

### 60V 17A N-Channel Enhancement Mode Power MOSFET

#### **FEATURES**

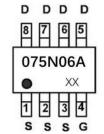
- RDSON $\leq$ 9m $\Omega$  @Vgs=10V, Id=15A
- Excellent RDS(ON) and Low Gate Charge
- · Lead free product is acquired

### **APPLICATION**

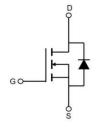
- Load Switch
- PWM Application
- · Power management



SOP-8 top view



**Marking and pin Assignment** 



**Schematic Diagram** 

Version: 1.0

### **ASSEMBLY MESSAGE**

Product Name	Marking	Package	Packaging
BXT090N06B	075N06A	SOP-8	Reel

### **ABSOLUTE MAXIMUM RATINGS** (Tc=25°C unless otherwise noted)

Parameter		Symbol	Rating SOP-8	Unit
Drain-Source Voltage		V <sub>DSS</sub>	60	V
D : 0	Continuous (T <sub>C</sub> = 25°C)		17	Α
Drain Current	Continuous (T <sub>C</sub> = 100°C)	─ I <sub>D</sub>	11	Α
Drain Current	Pulsed (Note1)	I <sub>DM</sub>	68	Α
Gate-Source Voltage		V <sub>GSS</sub>	±20	V
Single Pulsed Avalanche Energy (note2)		EAS	140	mJ
Power Dissipation T <sub>C</sub> =25°C		PD	4.8	W
Maximum Junction Temperature		TJ	150	°C
Storage Temperature Range		T <sub>STG</sub>	-55 to 150	°C

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. EAS condition : TJ=25  $^{\circ}\text{C}$  ,VDD=30V,VG=10V,L=0.5mH,Rg=25 $\Omega$ ,IAS=23.7A



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## THERMAL CHARACTERISTICS

Parameter	Symbol	Max.	Unit	
	- J	SOP-8		
Thermal Resistance, Junction to Ambient	Reja	26	°C/W	

### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C,unless otherwise Noted)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
OFF CHARACTERISTICS	'					
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	VGS=0V, ID=250µA	60			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	VDS=60V, VGS=0V			1	uA
Gate-Body Leakage Current, Forward		VGS=20V			100	nA
Gate-Body Leakage Current, Reverse	$I_{GSS}$	VGS=-20V			-100	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	VDS=VGS, ID=250µA	1.0	1.7	2.5	V
Davis Course On Otata Basistana	Б	VGS=10V, ID=15A		6.7	9	mΩ
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	VGS=4.5V, ID=10A		8.5	12	mΩ
DYNAMIC PARAMETERS			•		•	•
Input Capacitance	Ciss	VDS=25V, VGS=0V, f=1.0MHz		1100		pF
Output Capacitance	Coss			302		pF
Reverse Transfer Capacitance	Crss			27		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	t <sub>D(ON)</sub>			9.2		ns
Turn-ON Rise Time	t <sub>R</sub>	VDD=30V, ID=15A, VGS =		6.2		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	10V, RG=1.8Ω		33.1		ns
Turn-OFF Fall-Time	t <sub>F</sub>			7.6		ns
Total Gate Charge(Note3)	$Q_{G}$	VDS -20V VCS -40V ID		99		nC
Gate Source Charge	Q <sub>G</sub> s	VDS =30V, VGS =10V, ID = 10A		12.6		nC
Gate Drain Charge	$Q_{GD}$			32.1		nC
SOURCE- DRAIN DIODE RATINGS	AND CHAR	ACTERISTICS				
Drain-Source Diode Forward Voltage	V <sub>SD</sub>	IS=15A, VGS=0V			1.2	V
Diode Continuous Forward Current	Is				17	Α
Maximum Pulsed Drain to Source	love				68	
Diode Forward Current	İsm				00	A
Body Diode Reverse Recovery Time	trr	IF=15A,dI/dt=100A/μs		30		ns
Body Diode Reverse Recovery Charge	Qrr			49		nC

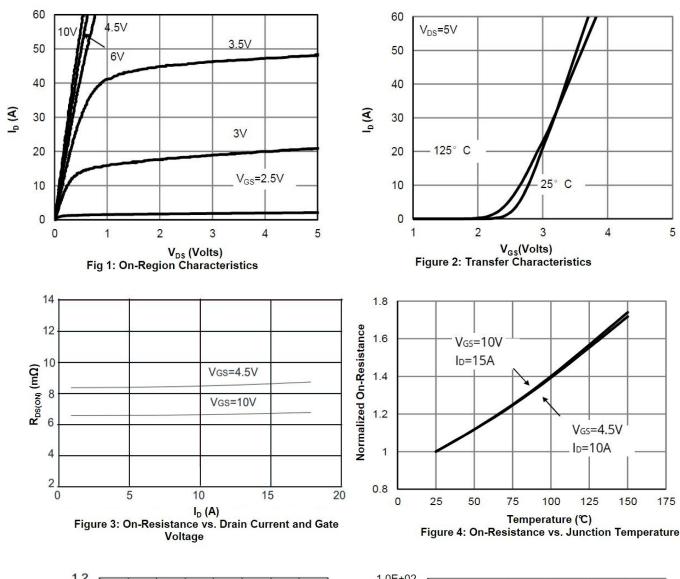
Note: 3. Essentially independent of operating temperature

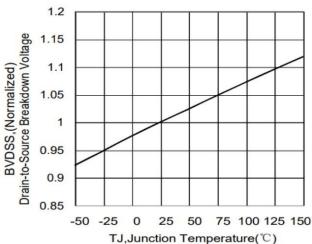
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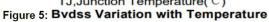
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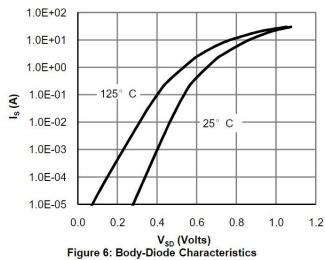


#### **TYPICAL CHARACTERISTICS**



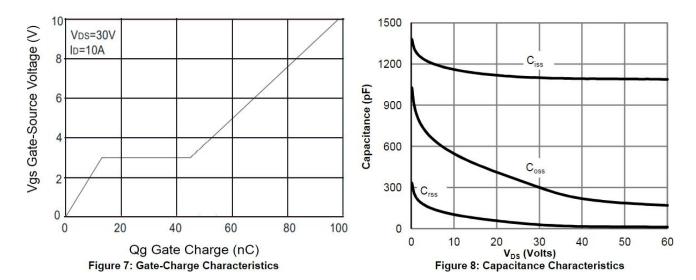








## **TYPICAL CHARACTERISTICS(Cont.)**



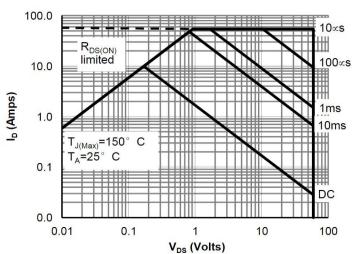
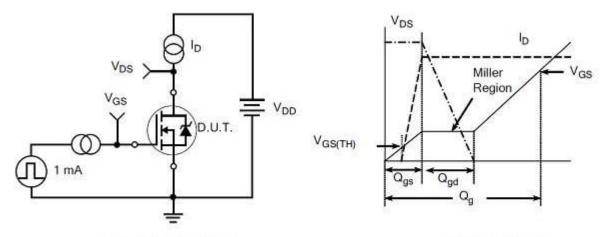


Figure 9: Maximum Forward Biased Safe Operating Area

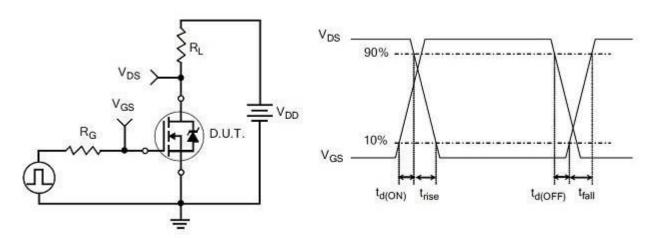


### **TEST CIRCUITS AND WAVEFORMS**



Gate Charge Test Circuit

Gate Charge Waveform

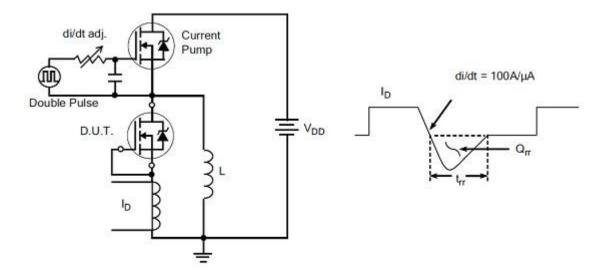


Resistive Switching Test Circuit

Resistive Switching Waveforms

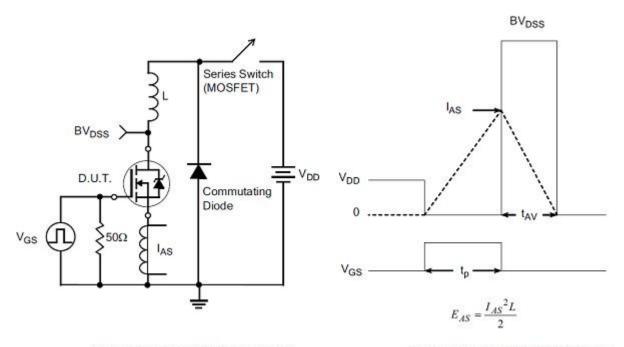


# TEST CIRCUITS AND WAVEFORMS(Cont.)



Diode Reverse Recovery Test Circuit

Diode Reverse Recovery Waveform

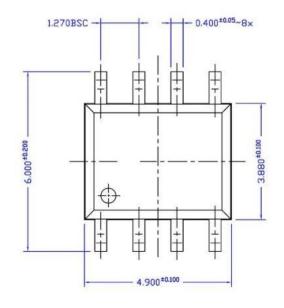


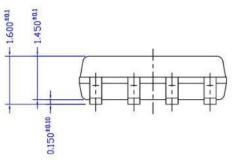
Unclamped Inductive Switching Test Circuit

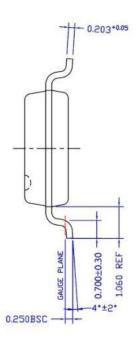
Unclamped Inductive Switching Waveforms



# **SOP-8 Package**







# **Revision history**

# **Document revision history**

Date	Revision	Changes
20-Mar-2021	1.0	First release

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